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FORM PTO-1596
1-31-92U.S. DEPARTMENT OF COMMERCE
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DOCKET NO.: LGS/K-055

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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereto:

1. Name of conveying party(ies):
Sung-Kye PARK and Eun-Jeong SHINMRP
7-20-98

2. Name and address of receiving party(ies):

Name: LG SEMICON CO., LTD.

Internal Address:

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

Street Address: 1, Hvangjeong-dong, Heungduk-ku

City: Cheongju-si

State/Country: Chungcheongbuk-do, KOREA ZIP: 360-480

Execution Date: June 22, 1998

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

09118812

If the document is being filed together with a new application, the execution date of the application is: June 22, 1998.

A. Patent Application No(s):
Filed:

B. Patent No(s)

Additional numbers attached? ☐ Yes ☒ No5. Name and address of party to whom correspondence
concerning document should be mailed:

Name: FLESHNER & KIM

Internal Address:

Street Address: P. O. Box 221200

City: Chantilly State: VA ZIP: 20153-1200

6. Total number of applications and patents involved: 1

7. Total fee (37 C.F.R. 3.41)..... \$40.00

☒ Enclosed (Check No. 6009)☐ Authorized to be charged to deposit account

8. Deposit account number:

16-0607

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9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*Carl R. Wesolowski, Reg. No. 40,372
Name and Registration No. of Person Signing

Signature

July 20, 1998
Date

Total number of pages including cover sheet: 2

CMB No. 0851-0011 (exp. 4/94)

07/23/1998 JSHABAZZ 00000154 09118812

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40.00 OP

PATENT
REEL: 9334 FRAME: 0473

Docket No.: _____

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

(1) Sung Kye PARK (4) _____
(2) Eun Jeong SHIN (5) _____
(3) _____ (6) _____

who have made a certain new and useful invention, hereby sell, assign and transfer unto

LG Semicon Co., Ltd.

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE SAME

(a) for which an application for United States Letters Patent was filed on _____ and identified by United States Serial No. _____; or

(b) for which an application for United States Letters Patent was executed on _____

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred

SIGNED on the dates indicated aside our signatures:
INVENTORS

DATE SIGNED

1) SUNG-KYE PARK
Name: Sung Kye PARK
2) Eun-Jeong Shin
Name: Eun Jeong SHIN

June 22, 1998
June 22, 1998

3) _____
Name: _____

4) _____
Name: _____

5) _____
Name: _____